

Features

- Low Equivalent on Resistance
- Extremely Low Leakage (Typically 6 μ A @30V)
- High Current Capability ($I_F = 1.16$ A)
- Low V_F , Fast Switching Schottky
- SOT23 Package
- ZLLS1000 Complements Low Temperature Equivalent ZHCS1000
- Package Thermally Rated to +150°C
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **An Automotive-Compliant Part is Available Under Separate Datasheet ([ZLLS1000QTA](#))**

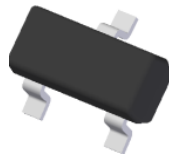
Mechanical Data

- Case: SOT23
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 **(e3)**
- Weight: 0.008 grams (Approximate)

Applications

- DC-DC Converters
- Strobes
- Mobile Phones
- Charging Circuits
- Motor Control

SOT23



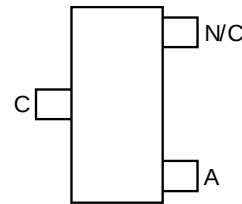
Top View

Cathode



Anode

Device Symbol



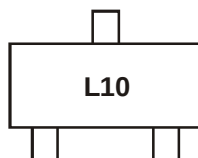
Pinout – Top View

Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
ZLLS1000TA	L10	7	8	3,000 Units

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



L10 = Product Type Marking Code

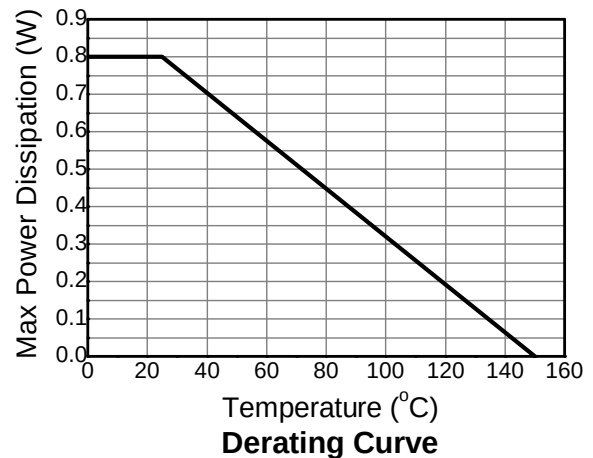
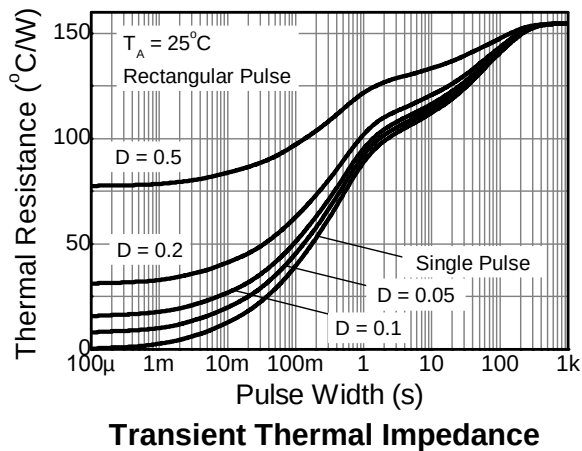
Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	40	V
Forward Current	I _F	1.16	A
Peak Repetitive Forward Current	I _{FPK}	2.6	A
Rectangular Pulse Duty Cycle 50% 100µs Pulse Width			
Non Repetitive Forward Current	I _{FSM}	22	A
t ≤ 100µs		6.4	A
t ≤ 10ms			

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation @T _A = +25°C	P _D	0.8	W
Single Die Continuous		1.18	
Single Die Measured at t < 5s			
Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	155	°C/W
Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	106	°C/W
Thermal Resistance Junction to Lead (Solder Point)	R _{θJL}	80	°C/W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Junction Temperature	T _J	+150	°C

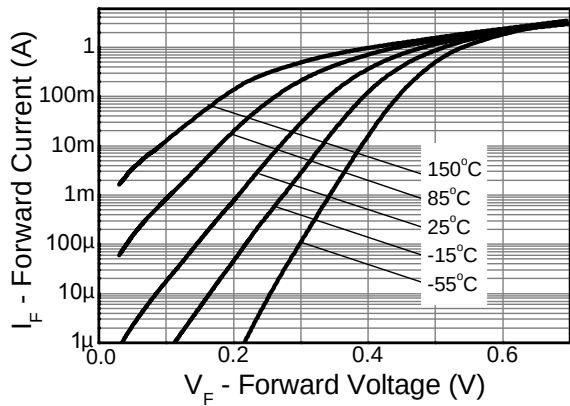
Notes: 5. For a device surface mounted on 25mm x 25mm FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions.
 6. For a device mounted on FRB PCB measured at t < 5s.

Thermal Characteristics and Derating information


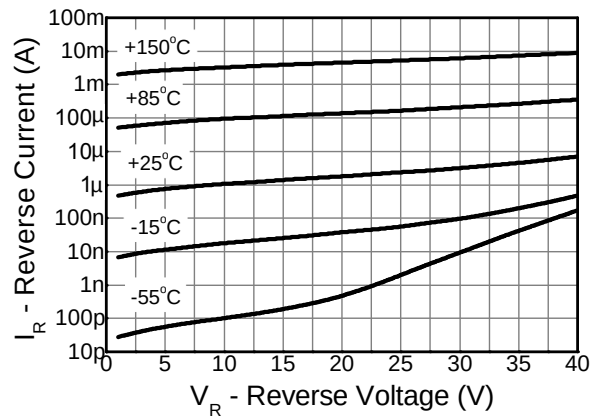
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	40	—	—	V	I _R = 500μA
Forward Voltage (Note 7)	V _F	—	320	355	mV	I _F = 50mA
			335	380		I _F = 100mA
			380	425		I _F = 250mA
			410	460		I _F = 500mA
			440	510		I _F = 750mA
			470	560		I _F = 1A
			530	660		I _F = 1.5A
			430	—		I _F = 1000mA, T _A = +100°C
Reverse Current	I _R	—	5 500	20 —	μA μA	V _R = 30V V _R = 30V, T _A = +85°C
Diode Capacitance	C _D	—	28	—	pF	f = 1MHz, V _R = 30V
Reverse Recovery Time	t _{RR}	—	5	—	ns	Switched from I _F = 500mA to V _R = 5.5V
Reverse Recovery Charge	Q _{RR}	—	350	—	nC	Measured @ I _R 50mA, di/dt = 500mA/ns R _{SOURCE} = 6Ω; R _{LOAD} = 10Ω

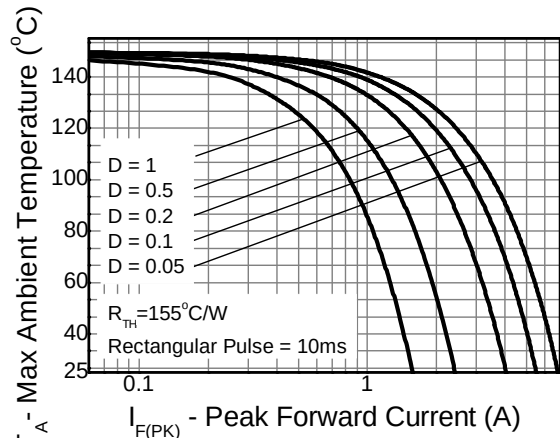
Note: 7. Measured under pulsed conditions. Pulse width = 300μs. Duty cycle < 2%.



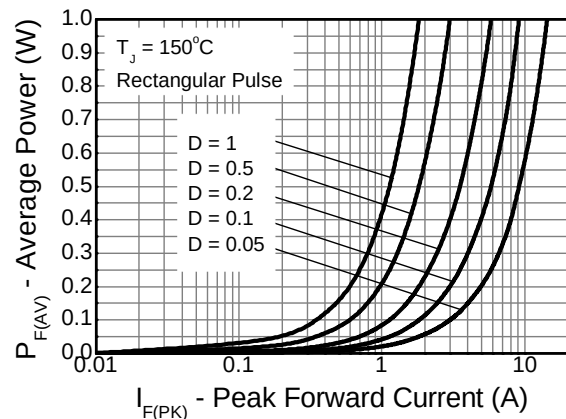
Typical Forward Characteristics



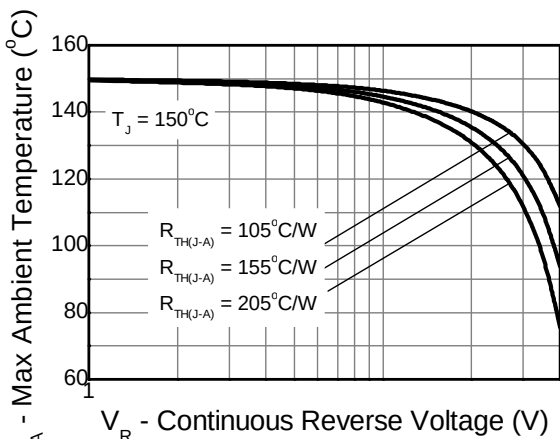
Typical Reverse Characteristics



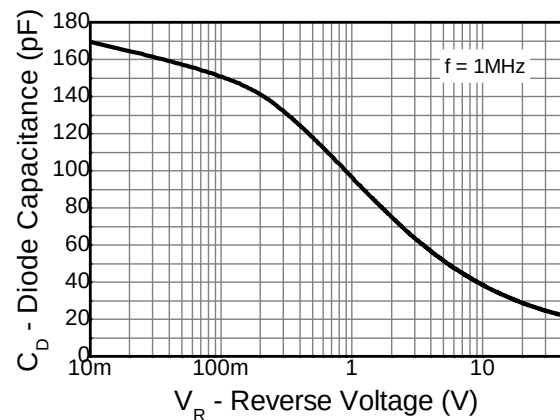
Typical Forward Safe Operating Area



Forward Power vs Peak Current



Typical Reverse Safe Operating Area

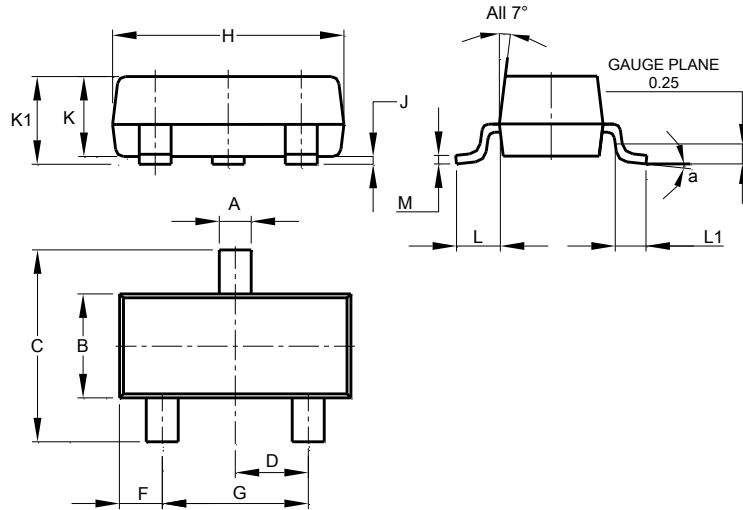


Capacitance vs Reverse Voltage

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23

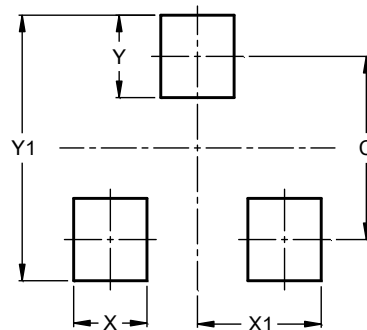


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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